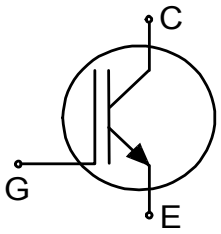
High speed series fifth generation

High speed 5 IGBT in TRENCHSTOP™ 5 technology

Features and Benefits:



High speed H5 technology offering
• Best-in-Class efficiency in hard switching and resonant topologies
• Plug and play replacement of previous generation IGBTs
• 650V breakdown voltage
• Low Q_G
• Maximum junction temperature 175°C
• Qualified according to JEDEC for target applications
• Pb-free lead plating; RoHS compliant
• Complete product spectrum and PSpice Models: http://www.infineon.com/igbt/

Applications:

• Uninterruptible power supplies
• Solar converters
• Welding converters
• Mid to high range switching frequency converters

Package pin definition:

• Pin 1 - gate
• Pin 2 & backside - collector
• Pin 3 - emitter

Green

Halogen-Free

RoHS

Key Performance and Package Parameters

Type	V_{CE}	I_C	V_{CEsat}, T_{vj}=25°C	T_{vjmax}	Marking	Package
IGW75N65H5	650V	75A	1.65V	175°C	G75EH5	PG-TO247-3

Table of Contents

Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_{vj} \geq 25°C$	V_{CE}	650	V
DC collector current, limited by T_{vjmax} T_C = 25°C value limited by bondwire T_C = 100°C	I_C	 120.0 75.0	A
Pulsed collector current, t_p limited by T_{vjmax} [1)]	I_{Cpuls}	300.0	A
Turn off safe operating area $V_{CE} \leq 650V$, $T_{vj} \leq 175°C$, t_p = 1µs [1)]	-	300.0	A
Gate-emitter voltage Transient Gate-emitter voltage ($t_p \leq 10µs$, $D < 0.010$)	V_{GE}	±20 ±30	V
Power dissipation T_C = 25°C Power dissipation T_C = 100°C	P_{tot}	395.0 198.0	W
Operating junction temperature	T_{vj}	-40...+175	°C
Storage temperature	T_{stg}	-55...+150	°C
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C
Mounting torque, M3 screw, PG-TO247-pin123 Maximum of mounting processes: 3	M	0.6	Nm

Thermal Resistance

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
R_{th} Characteristics						
IGBT thermal resistance, junction - case	$R_{th(j-C)}$		-	-	0.38	K/W
Thermal resistance junction - ambient	$R_{th(j-a)}$		-	-	40	K/W

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	V_{GE} = 0V, I_C = 0.20mA	650	-	-	V
Collector-emitter saturation voltage	V_{CEsat}	V_{GE} = 15.0V, I_C = 75.0A T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 175°C	 - - -	 1.65 1.85 1.95	 2.10 - -	V
Gate-emitter threshold voltage	$V_{GE(th)}$	I_C = 0.75mA, V_{CE} = V_{GE}	3.2	4.0	4.8	V
Zero gate voltage collector current	I_{CES}	V_{CE} = 650V, V_{GE} = 0V T_{vj} = 25°C T_{vj} = 175°C	 - -	 0 800	 75 -	µA
Gate-emitter leakage current	I_{GES}	V_{CE} = 0V, V_{GE} = 20V	-	-	100	nA
Transconductance	g_{fs}	V_{CE} = 20V, I_C = 75.0A	-	104.0	-	S

[1)] Defined by design. Not subject to production test.

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Dynamic Characteristic						
Input capacitance	C_{ies}	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz	-	3800	-	pF
Output capacitance	C_{oes}		-	80	-	
Reverse transfer capacitance	C_{res}		-	17	-	
Gate charge	Q_G	V_{CC} = 520V, I_C = 75.0A, V_{GE} = 15V	-	160.0	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L_E		-	13.0	-	nH

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
IGBT Characteristic, at T_{vj} = 25°C						
Turn-on delay time	$t_{d(on)}$	T_{vj} = 25°C, V_{CC} = 400V, I_C = 75.0A, V_{GE} = 0.0/15.0V, $R_{G(on)}$ = 8.0Ω, $R_{G(off)}$ = 8.0Ω, Lσ = 30nH, Cσ = 25pF Lσ, Cσ from Fig. E Energy losses include “tail” and diode reverse recovery. Diode from IKW75N65EH5.	-	28	-	ns
Rise time	t_r		-	33	-	ns
Turn-off delay time	$t_{d(off)}$		-	174	-	ns
Fall time	t_f		-	41	-	ns
Turn-on energy	E_{on}		-	2.25	-	mJ
Turn-off energy	E_{off}		-	0.95	-	mJ
Total switching energy	E_{ts}		-	3.20	-	mJ
Turn-on delay time	$t_{d(on)}$	T_{vj} = 25°C, V_{CC} = 400V, I_C = 37.5A, V_{GE} = 0.0/15.0V, $R_{G(on)}$ = 8.0Ω, $R_{G(off)}$ = 8.0Ω, Lσ = 30nH, Cσ = 25pF Lσ, Cσ from Fig. E Energy losses include “tail” and diode reverse recovery. Diode from IKW75N65EH5.	-	25	-	ns
Rise time	t_r		-	14	-	ns
Turn-off delay time	$t_{d(off)}$		-	178	-	ns
Fall time	t_f		-	18	-	ns
Turn-on energy	E_{on}		-	0.90	-	mJ
Turn-off energy	E_{off}		-	0.30	-	mJ
Total switching energy	E_{ts}		-	1.20	-	mJ

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
IGBT Characteristic, at T_{vj} = 150°C						
Turn-on delay time	$t_{d(on)}$	T_{vj} = 150°C, V_{CC} = 400V, I_C = 75.0A, V_{GE} = 0.0/15.0V, $R_{G(on)}$ = 8.0Ω, $R_{G(off)}$ = 8.0Ω, Lσ = 30nH, Cσ = 25pF Lσ, Cσ from Fig. E Energy losses include “tail” and diode reverse recovery. Diode from IKW75N65EH5.	-	27	-	ns
Rise time	t_r		-	34	-	ns
Turn-off delay time	$t_{d(off)}$		-	194	-	ns
Fall time	t_f		-	38	-	ns
Turn-on energy	E_{on}		-	3.00	-	mJ
Turn-off energy	E_{off}		-	1.00	-	mJ
Total switching energy	E_{ts}		-	4.00	-	mJ
Turn-on delay time	$t_{d(on)}$	T_{vj} = 150°C, V_{CC} = 400V, I_C = 37.5A, V_{GE} = 0.0/15.0V, $R_{G(on)}$ = 8.0Ω, $R_{G(off)}$ = 8.0Ω, Lσ = 30nH, Cσ = 25pF Lσ, Cσ from Fig. E Energy losses include “tail” and diode reverse recovery. Diode from IKW75N65EH5.	-	25	-	ns
Rise time	t_r		-	16	-	ns
Turn-off delay time	$t_{d(off)}$		-	207	-	ns
Fall time	t_f		-	14	-	ns
Turn-on energy	E_{on}		-	1.80	-	mJ
Turn-off energy	E_{off}		-	0.40	-	mJ
Total switching energy	E_{ts}		-	2.20	-	mJ

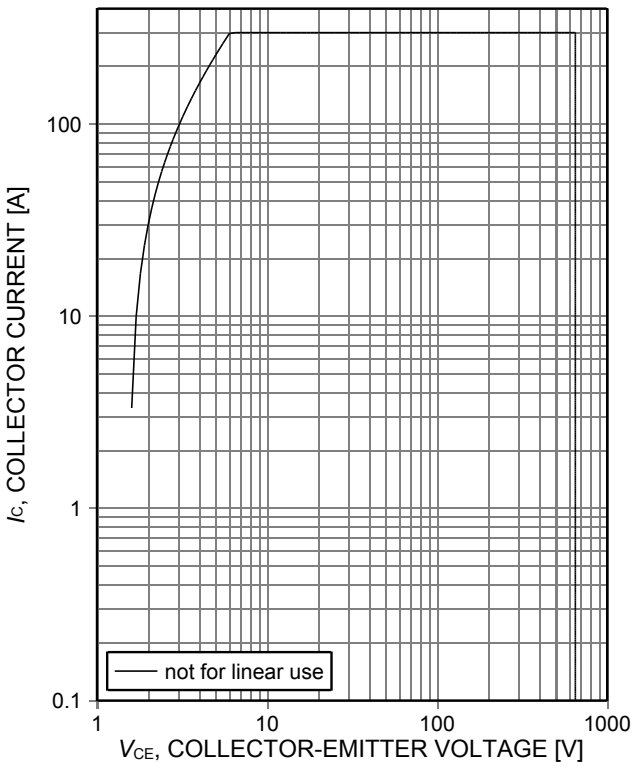


Figure 1. **Forward bias safe operating area** (D=0, T_C=25°C, T_{vj}≤175°C, V_{GE}=15V, t_p=1µs, I_{Cmax} defined by design - not subject to production test)

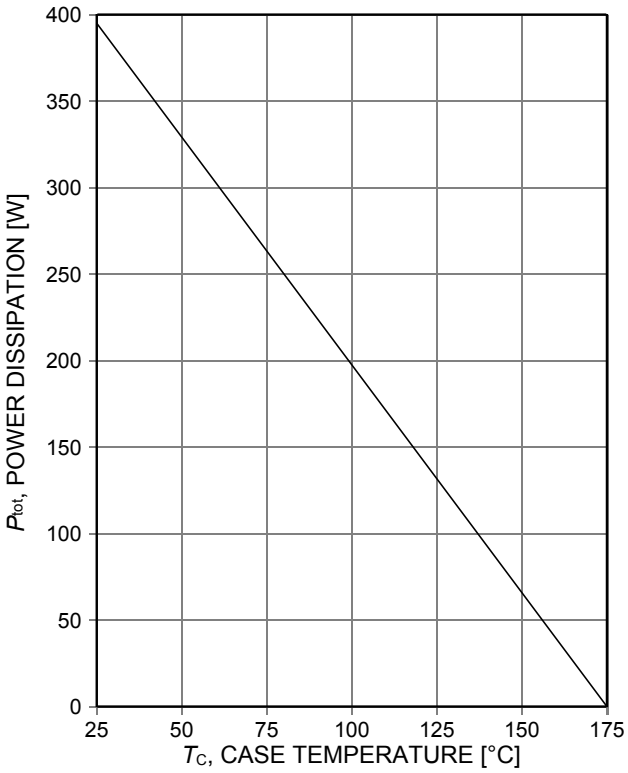


Figure 2. **Power dissipation as a function of case temperature** (T_{vj}≤175°C)

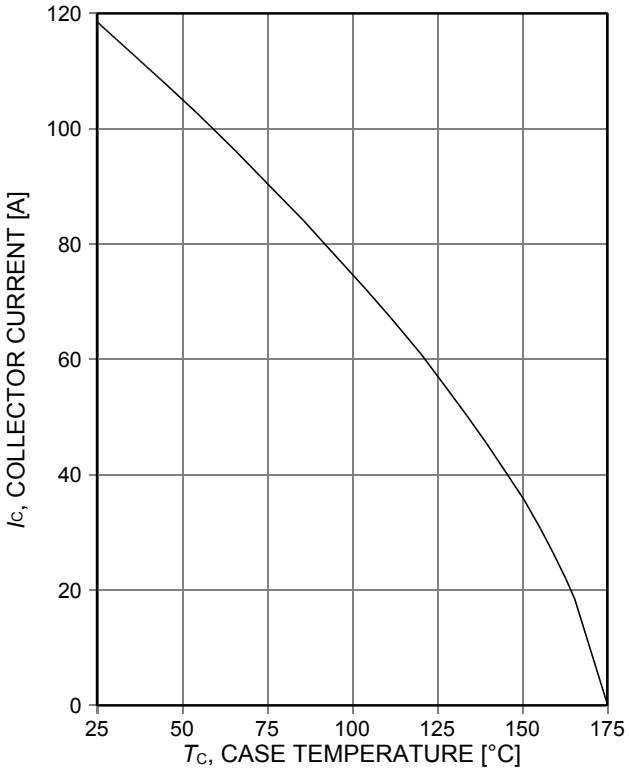


Figure 3. **Collector current as a function of case temperature** (V_{GE}≥15V, T_{vj}≤175°C)

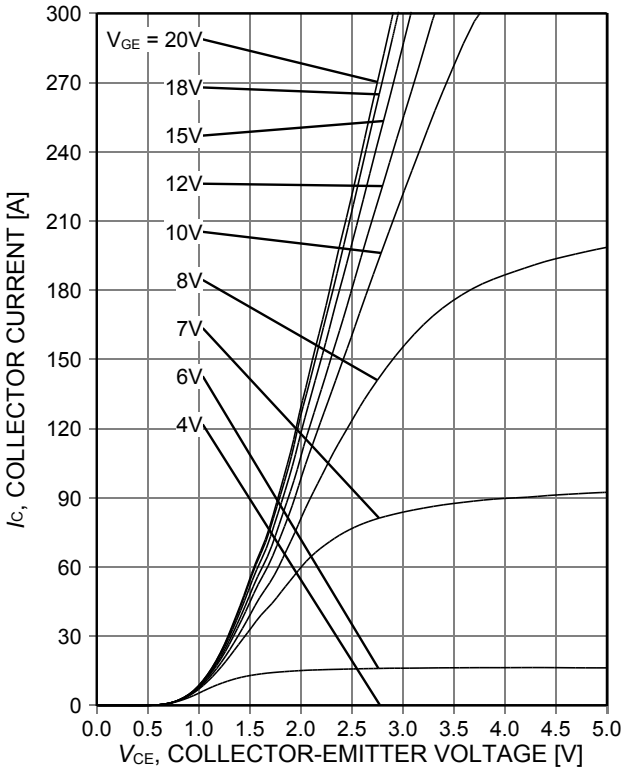


Figure 4. **Typical output characteristic** (T_{vj}=25°C)

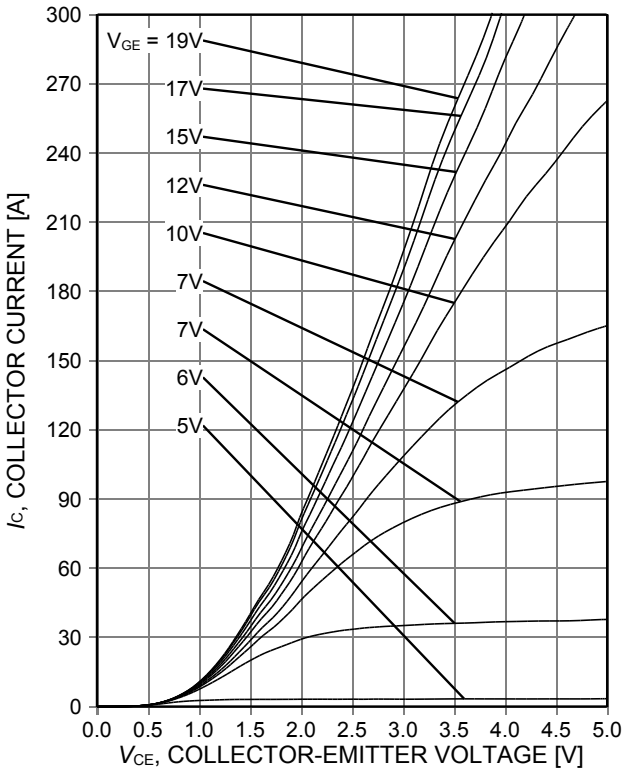


Figure 5. **Typical output characteristic** (T_{vj}=150°C)

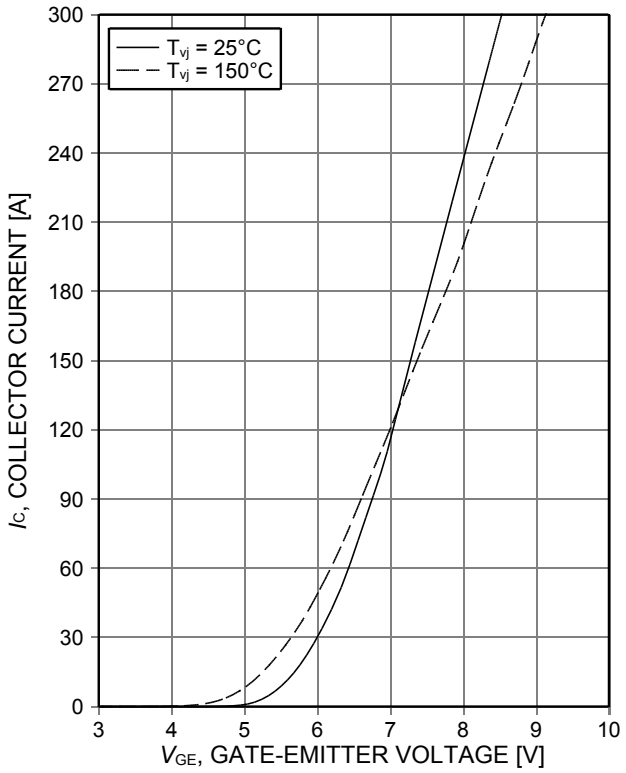


Figure 6. **Typical transfer characteristic** (V_{CE}=20V)

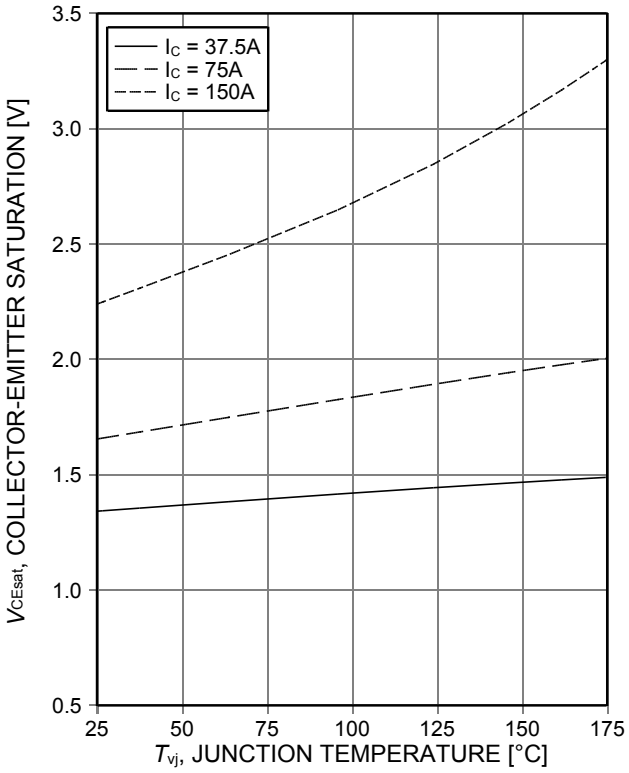


Figure 7. **Typical collector-emitter saturation voltage as a function of junction temperature** (V_{GE}=15V)

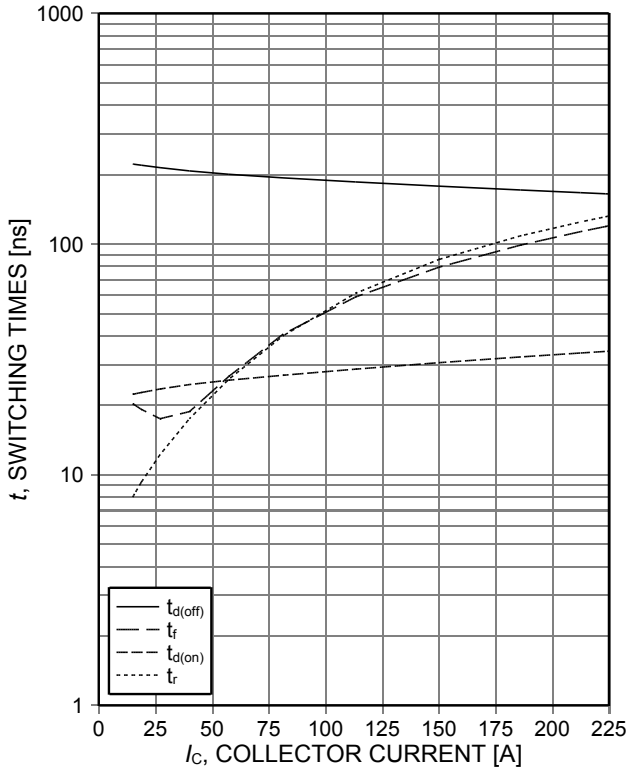


Figure 8. **Typical switching times as a function of collector current** (inductive load, T_{vj}=150°C, V_{CE}=400V, V_{GE}=0/15V, $R_{G(on)}$=8Ω, $R_{G(off)}$=8Ω, dynamic test circuit in Figure E)

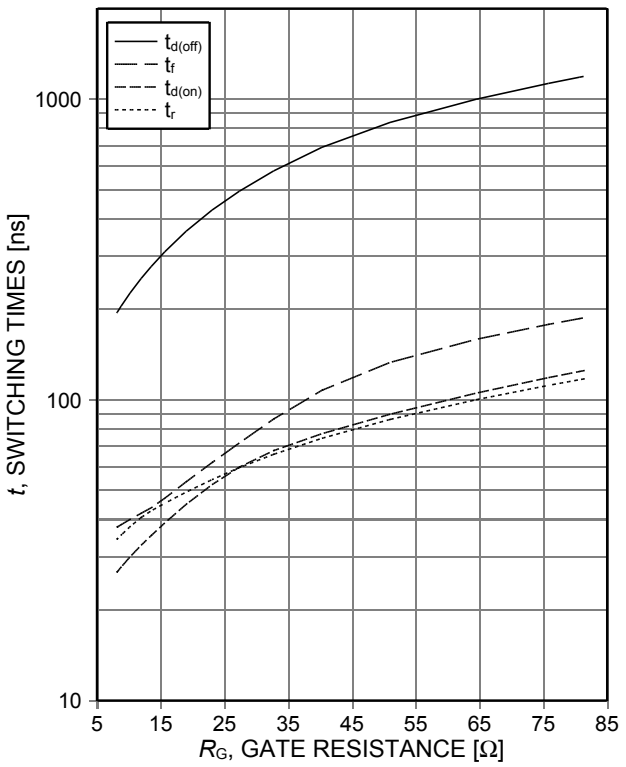


Figure 9. **Typical switching times as a function of gate resistance**
(inductive load, T_{vj}=150°C, V_{CE}=400V, V_{GE}=0/15V, I_C=75A, dynamic test circuit in Figure E)

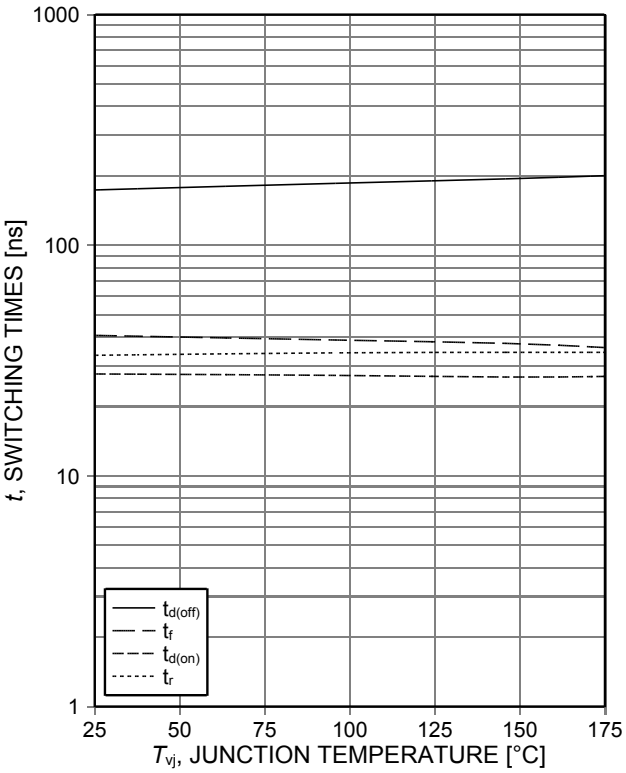


Figure 10. **Typical switching times as a function of junction temperature**
(inductive load, V_{CE}=400V, V_{GE}=0/15V, I_C=75A, $R_{G(on)}$=8Ω, $R_{G(off)}$=8Ω, dynamic test circuit in Figure E)

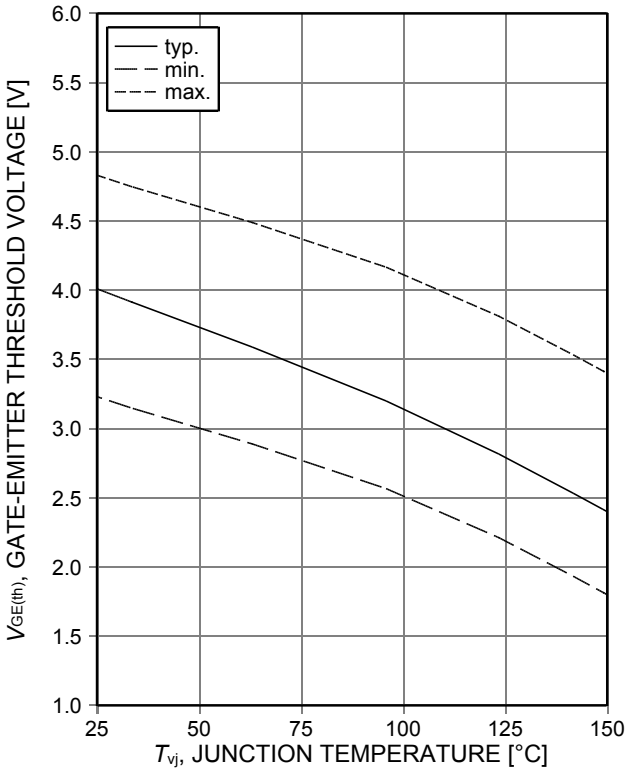


Figure 11. **Gate-emitter threshold voltage as a function of junction temperature**
(I_C=0.75mA)

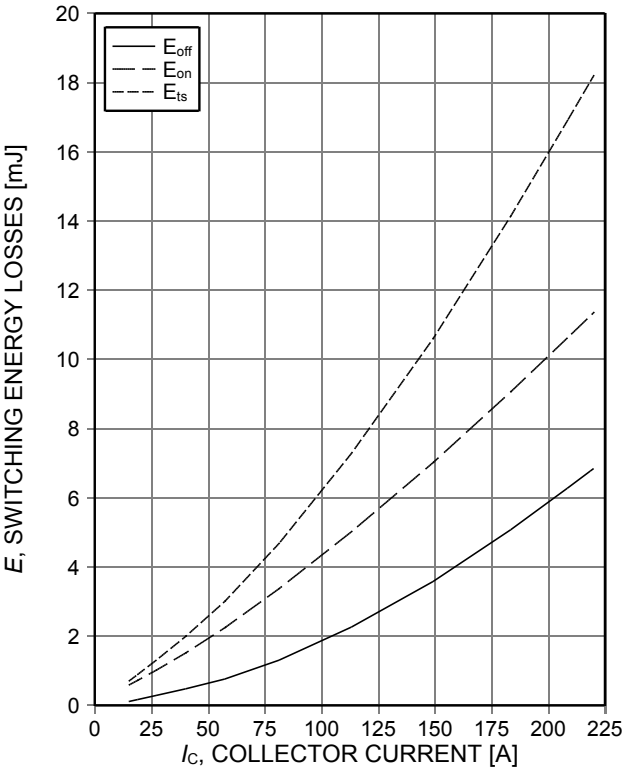


Figure 12. **Typical switching energy losses as a function of collector current**
(inductive load, T_{vj}=150°C, V_{CE}=400V, V_{GE}=0/15V, $R_{G(on)}$=8Ω, $R_{G(off)}$=8Ω, dynamic test circuit in Figure E)

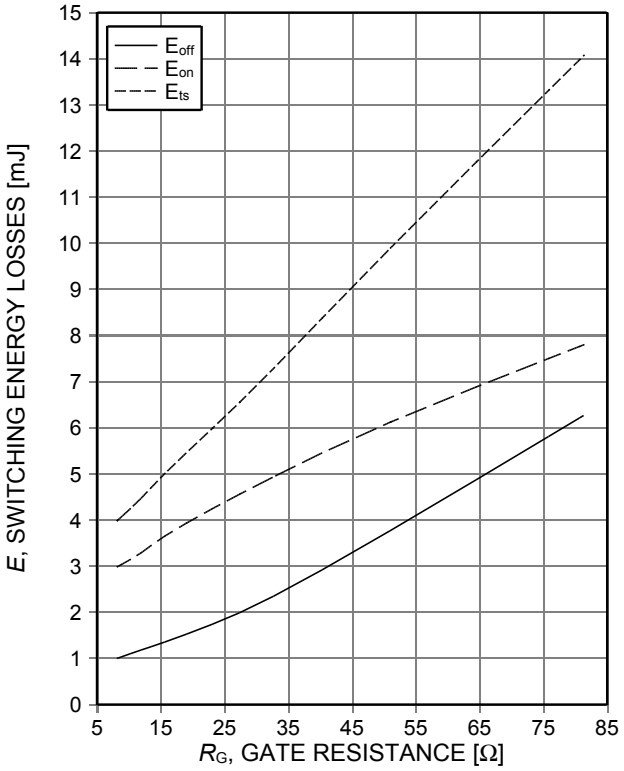


Figure 13. **Typical switching energy losses as a function of gate resistance** (inductive load, T_{vj}=150°C, V_{CE}=400V, V_{GE}=0/15V, I_C=75A, dynamic test circuit in Figure E)

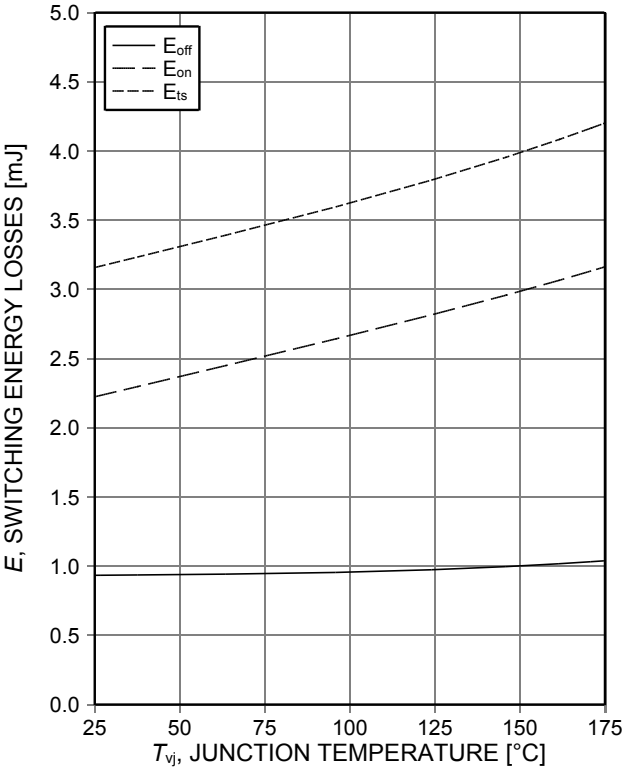


Figure 14. **Typical switching energy losses as a function of junction temperature** (inductive load, V_{CE}=400V, V_{GE}=0/15V, I_C=75A, $R_{G(on)}$=8Ω, $R_{G(off)}$=8Ω, dynamic test circuit in Figure E)

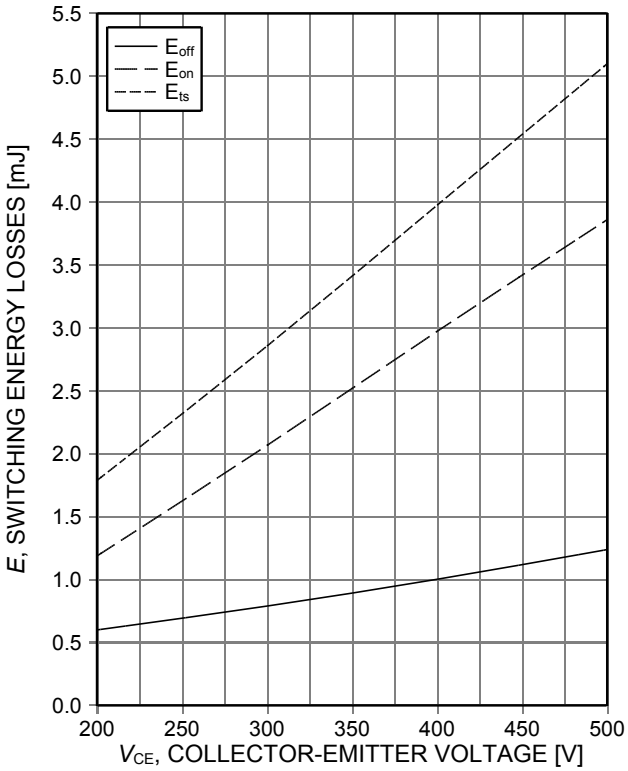


Figure 15. **Typical switching energy losses as a function of collector emitter voltage** (inductive load, T_{vj}=150°C, V_{GE}=0/15V, I_C=75A, $R_{G(on)}$=8Ω, $R_{G(off)}$=8Ω, dynamic test circuit in Figure E)

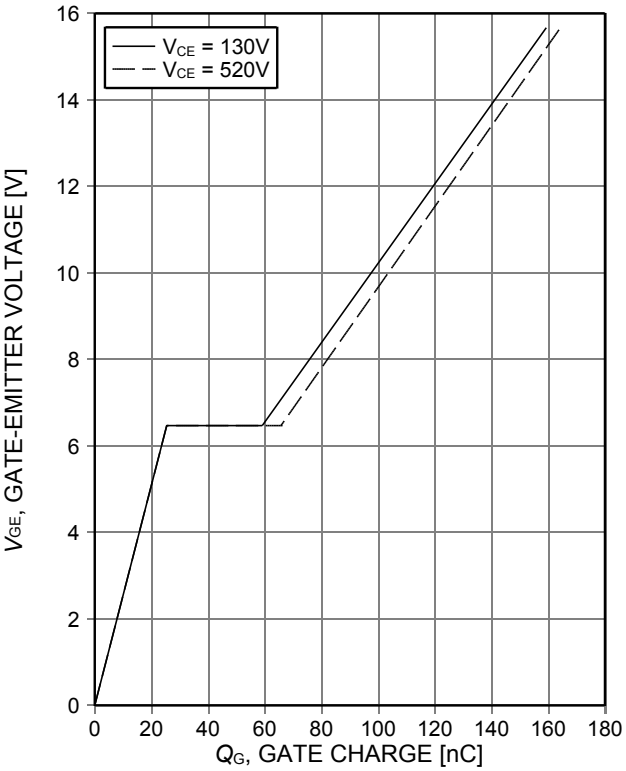


Figure 16. **Typical gate charge** (I_C=75A)

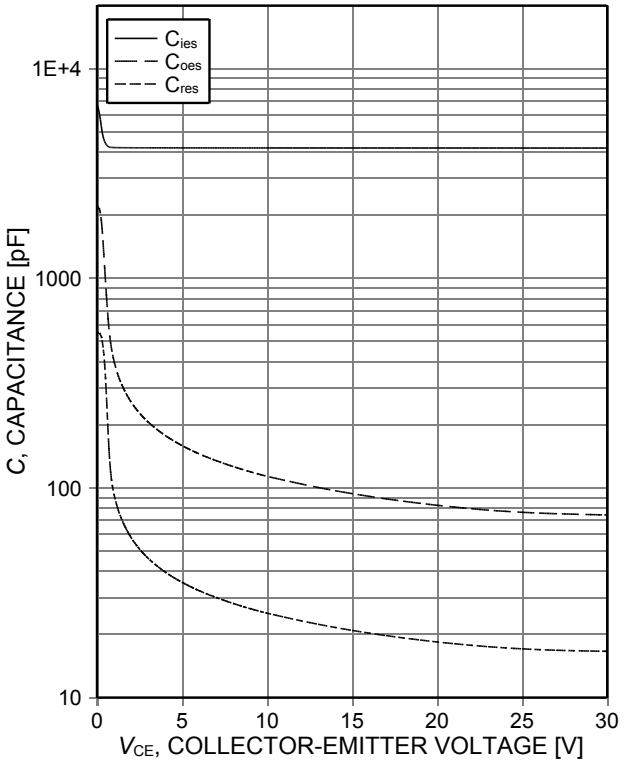


Figure 17. **Typical capacitance as a function of collector-emitter voltage**
(V_{GE}=0V, f=1MHz)

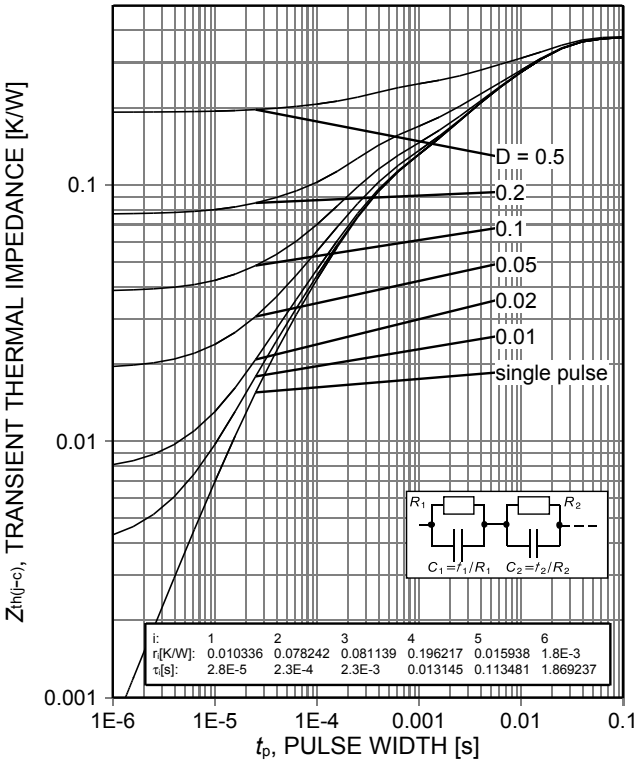
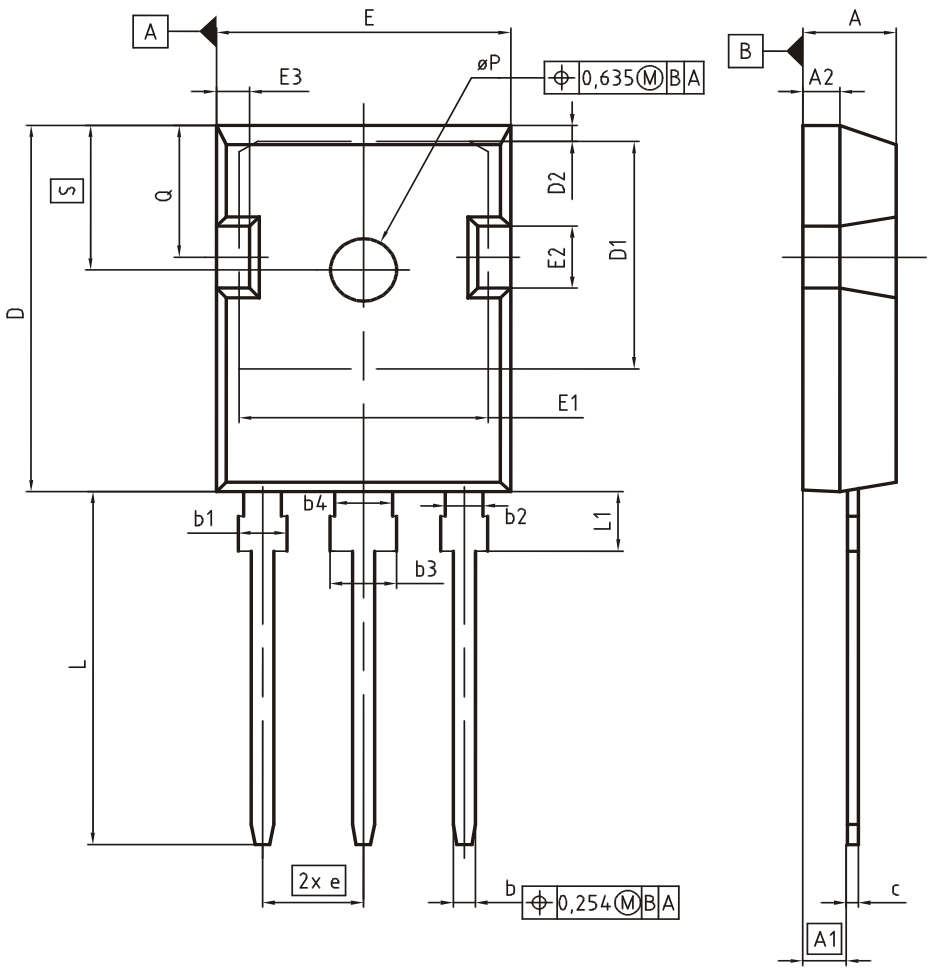


Figure 18. **IGBT transient thermal impedance**
(D=t_p/T)

Package Drawing PG-TO247-3



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
øP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248

DOCUMENT NO.	Z8B00003327
SCALE	0 5 5 7.5mm
EUROPEAN PROJECTION	
ISSUE DATE	09-07-2010
REVISION	05

Testing Conditions

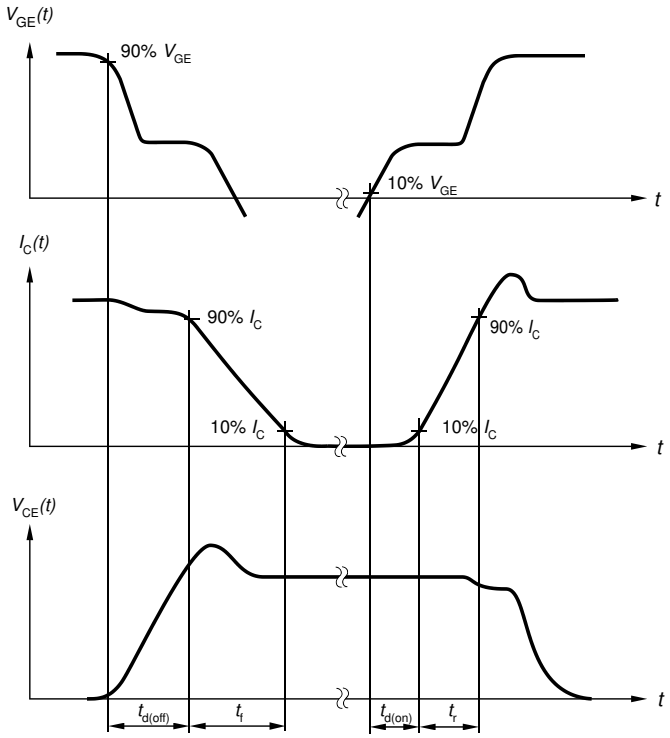


Figure A. **Definition of switching times**

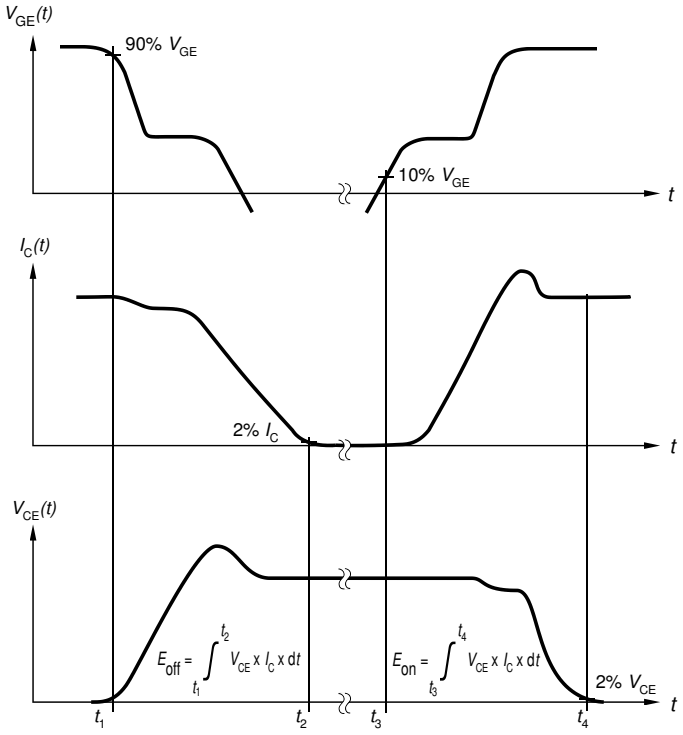


Figure B. **Definition of switching losses**

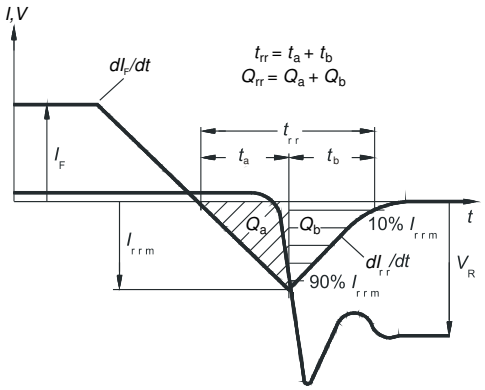


Figure C. **Definition of diode switching characteristics**

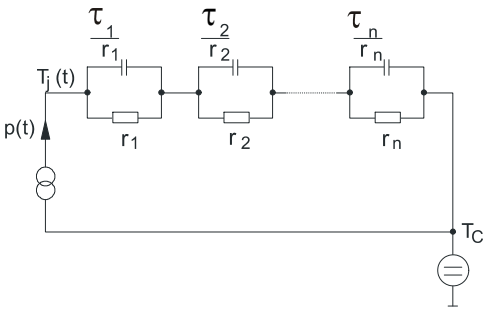


Figure D. **Thermal equivalent circuit**

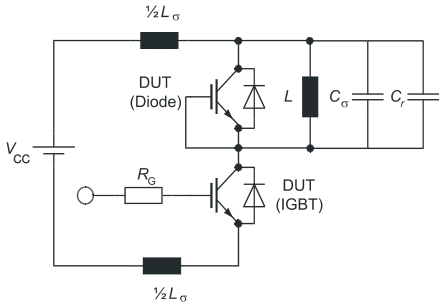


Figure E. **Dynamic test circuit**
Parasitic inductance L_σ,
parasitic capacitor C_σ,
relief capacitor C_r,
(only for ZVT switching)

Revision History

IGW75N65H5

Revision: 2017-07-27, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.1	2015-05-20	Final data sheet
2.2	2017-07-27	Correction Fig. 1

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- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «**JONHON**», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «**FORSTAR**».

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(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).

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